

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5942853

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YEOHUN YUN	01/21/2020
JOON HO CHO	12/18/2019
JUBUM KIM	12/19/2019
CHANHONG KIM	01/23/2020
JONGBU LIM	01/23/2020
SUNGNAM HONG	01/23/2020

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
Name:	POSTECH ACADEMY-INDUSTRY FOUNDATION
Street Address:	77, CHEONGAM-RO, NAM-GU
City:	POHANG-SI, GYEONGSANGBUK-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	37673

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16636131

CORRESPONDENCE DATA

Fax Number: (972)628-3616

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 972-628-3600

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Correspondent Name: DOCKET CLERK - SEC

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ATTORNEY DOCKET NUMBER:	SAMS06-18135
NAME OF SUBMITTER:	WILLIAM A. MUNCK
SIGNATURE:	/William A. Munck/
DATE SIGNED:	02/03/2020
Total Attachments: 4 source=10_SAMS06-18135_Assignment#page1.tif source=10_SAMS06-18135_Assignment#page2.tif source=10_SAMS06-18135_Assignment#page3.tif source=10_SAMS06-18135_Assignment#page4.tif	

ASSIGNMENT

WHEREAS, We, Yeobun YUN, a resident of Hwaseong-si, Gyeonggi-do, Republic of Korea, Joon Ho CHO, a resident of Seocho-gu, Seoul, Republic of Korea, Jubum KIM, a resident of Yangcheon-gu, Seoul, Republic of Korea, Chanhong KIM, a resident of Suwon-si, Gyeonggi-do, Republic of Korea, Jongbu LIM, a resident of Seocho-gu, Seoul, Republic of Korea and Sungnam HONG, a resident of Suwon-si, Gyeonggi-do, Republic of Korea, have invented certain new and useful improvements in a "DEVICE AND METHOD FOR PROCESSING RECEIVED SIGNAL IN WIRELESS COMMUNICATION SYSTEM" disclosed in an application for United States Letters Patent (Application No. _____, filed on _____, said application having been executed concurrently herewith;


WHEREAS, SAMSUNG ELECTRONICS CO., LTD., a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea, and POSTECH ACADEMY-INDUSTRY FOUNDATION, a corporation organized under the laws of the Republic of Korea, having a place of business at 77, Cheongam-ro, Nam-gu, Pohang-si, Gyeongsangbuk-do 37673, Republic of Korea (hereinafter referred to as "ASSIGNEES"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEES, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEES of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEES, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEES, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEES, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEES, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEES and to aid said ASSIGNEES, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: 2020. 01. 21


Yeobun YUN

Date: _____

Joon Ho CHO

Date: _____

Jubun KIM

Date: _____

Chanhong KIM

Date: _____

Jongbu LIM

Date: _____

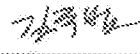
Sungnam HONG

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Date: _____
Yeohun YUN

Date: 2019/12/18

Joon Ho CHO

Date: 2019/12/19

Jubum KIM

Date: _____
Chanhong KIM

Date: _____
Jongbu LIM

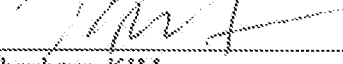
Date: _____
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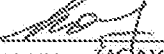
Date: _____
Yeohun YUN

Date: _____
Joon Ho CHO

Date: _____
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Date: 2020. 01. 23

Chanhong KIM

Date: 2020. 01. 23

Jongbu LIM

Date: 2020. 01. 23

Sungnam HONG